

650V 1.2ohm Super-Junction Power MOSFET

AKS65N1M2KM

Description:

This SJ device provides good FOM performance, better EMI for customer application.

Features:

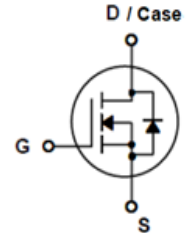
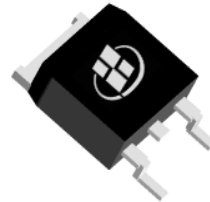
- Low FOM $R_{DS(ON)} \times Q_G$
- Better EMI
- 100% UIS tested
- RoHS compliant ^(Note 1)
- Halogen-free ^(Note 1)

Applications:

- High Frequency Switching
- Quick Charging and Adapter

Key Performance Parameters:

Parameter	Value	Unit
V_{DS}	650	V
$R_{DS(ON), max} @ V_{GS} = 10V$	1.2	Ω
I_D	3	A



Ordering Information:

Ordering Code	Package Type	Marking Code	Form	Packing
AKS65N1M2KM	TO-252	S65N1M2KM	13 Inches Reel	2500PCS

Notes:

1. Contact ALKAIDSEMI sales for detail information

Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Value	Units
V_{DS}	Drain-Source Voltage	650	V
I_D	Drain Current - Continuous ($T_C = 25^\circ\text{C}$) ^(Note 1)	4	A
	Drain Current - Continuous ($T_C = 100^\circ\text{C}$)	2.9	A
I_{DM}	Drain Current - Pulsed ^(Note 2)	12	A
V_{GS}	Gate-Source Voltage	± 30	V
E_{AS}	Single Pulsed Avalanche Energy ^(Note 3)	72	mJ
P_D	Power Dissipation ($T_C = 25^\circ\text{C}$)	62.5	W
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +150	$^\circ\text{C}$

Thermal Characteristics

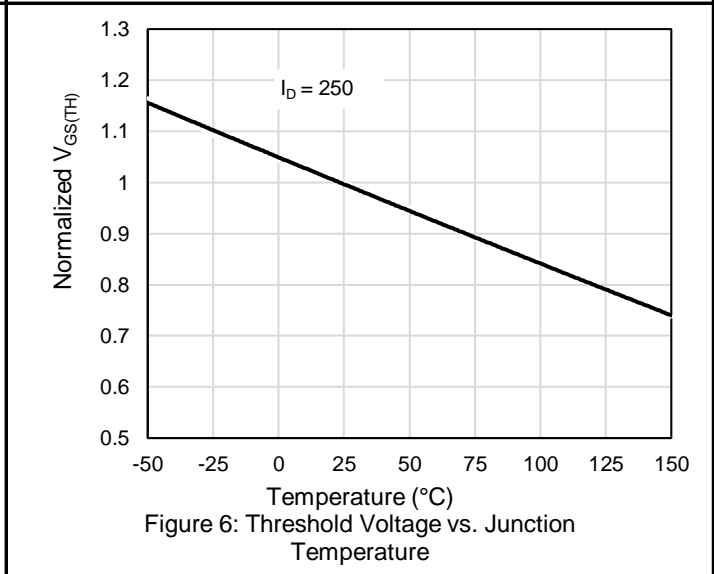
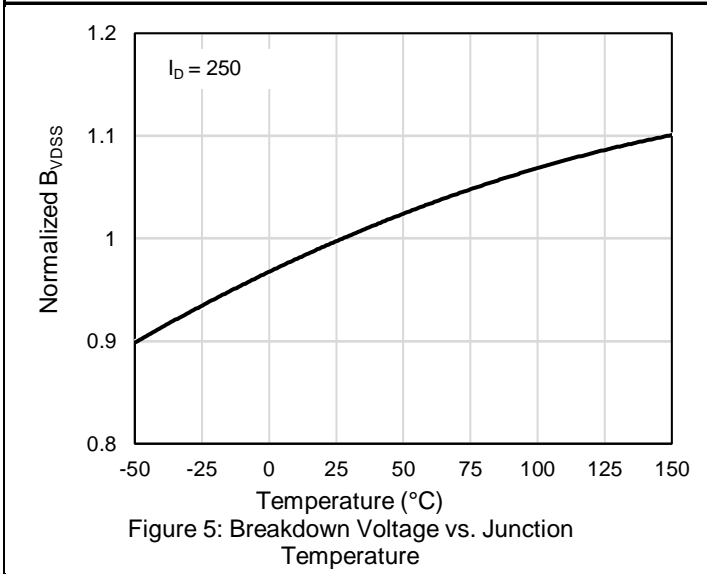
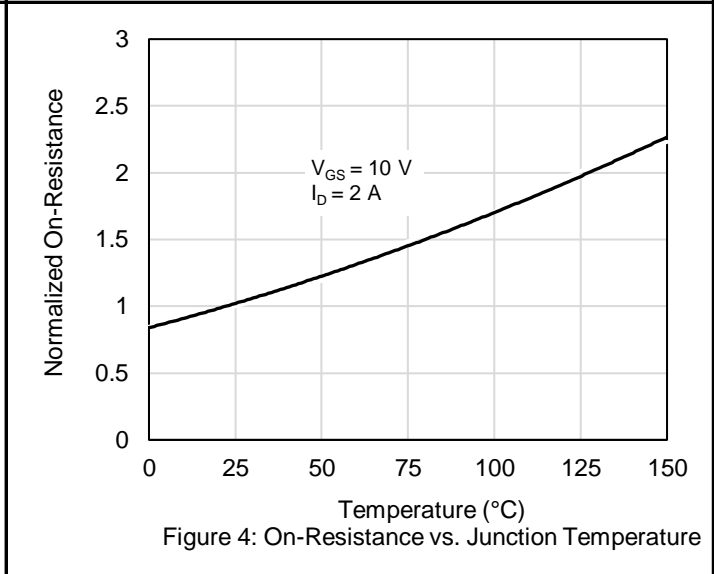
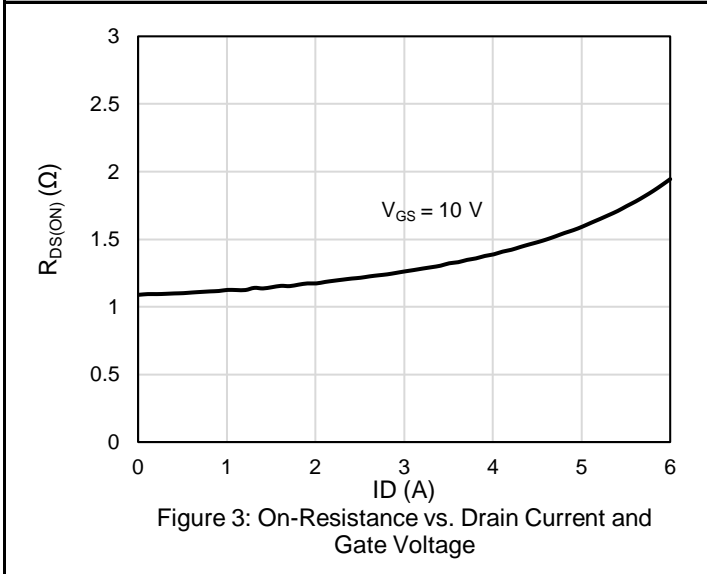
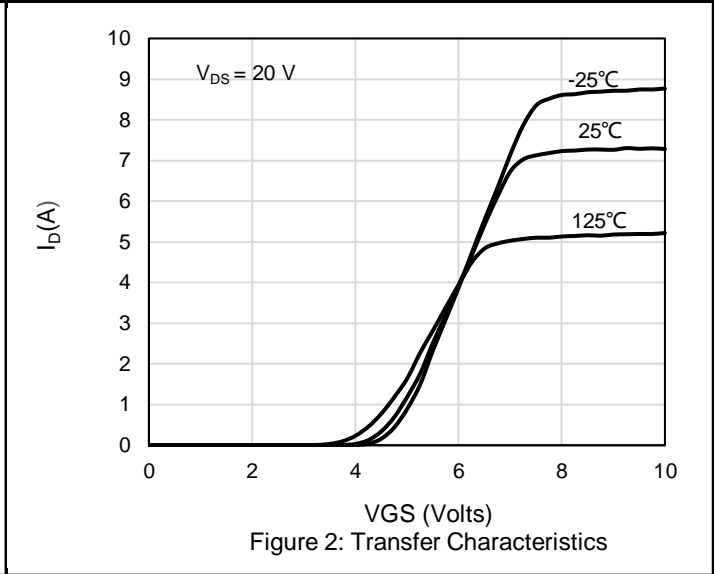
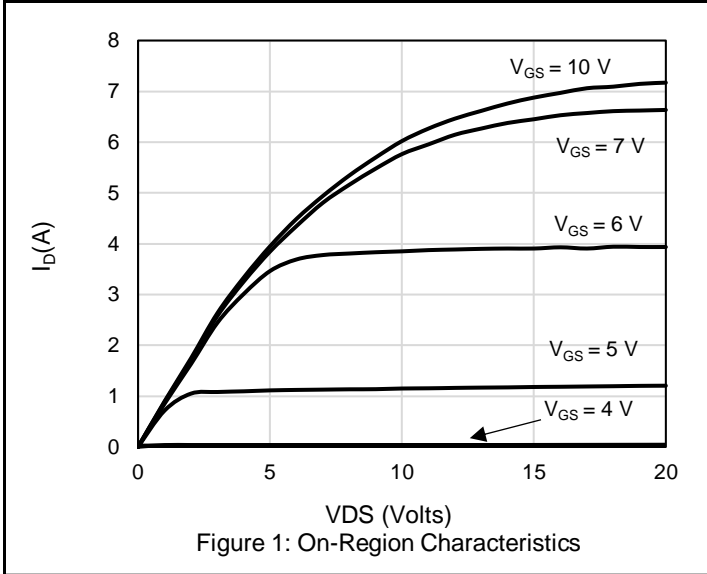
Symbol	Parameter	Value	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Steady-State	2	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Steady State ^(Note 4)	69	$^\circ\text{C}/\text{W}$

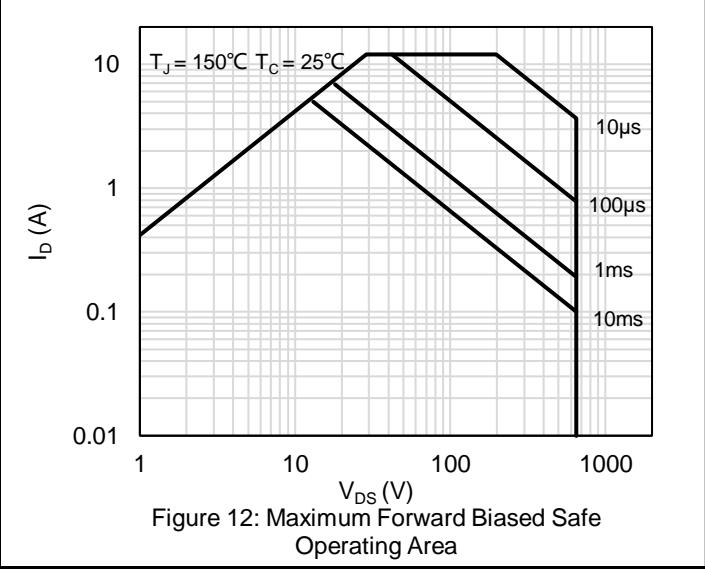
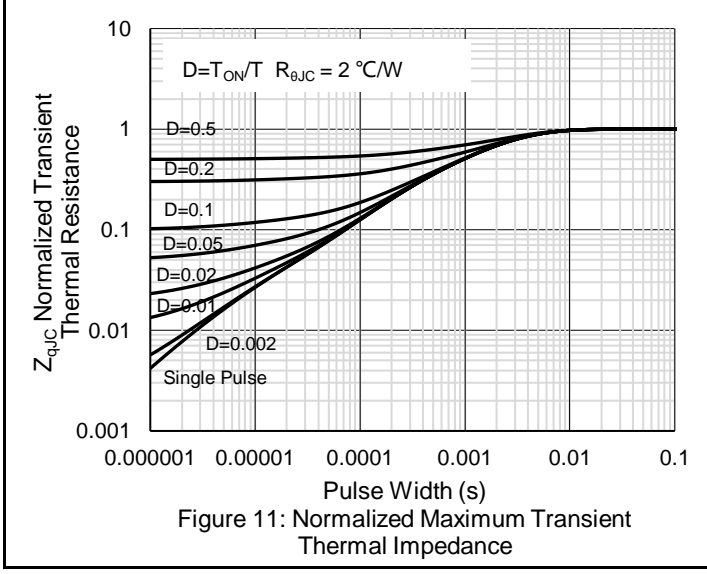
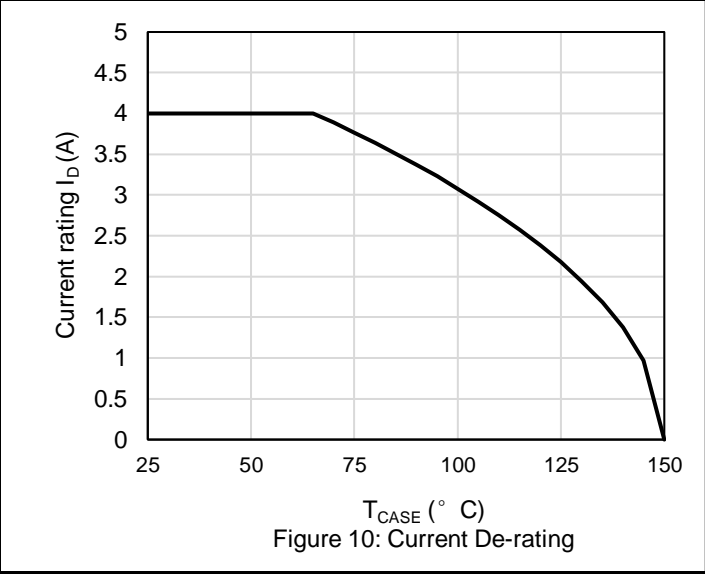
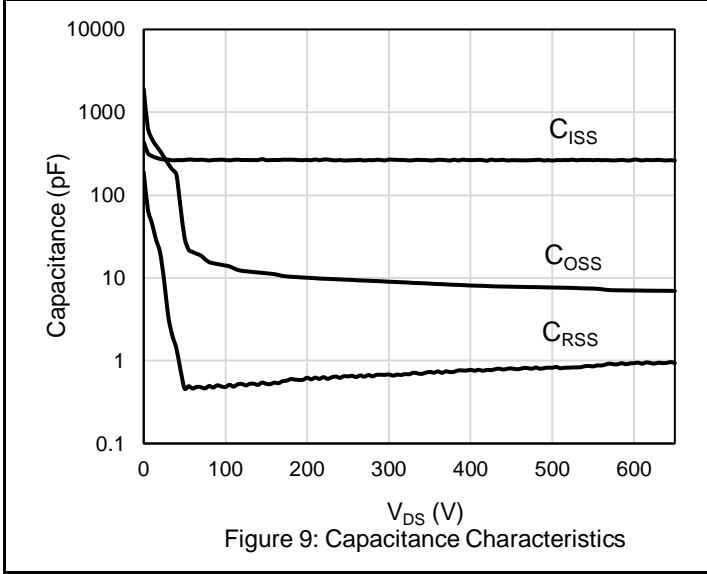
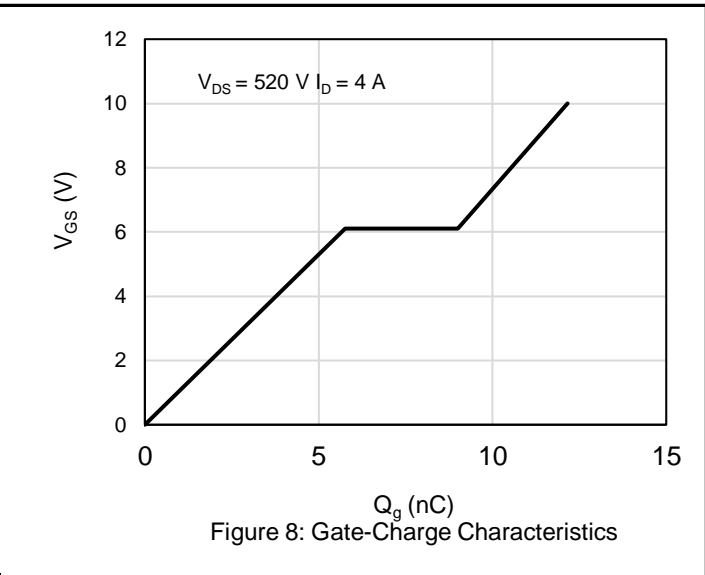
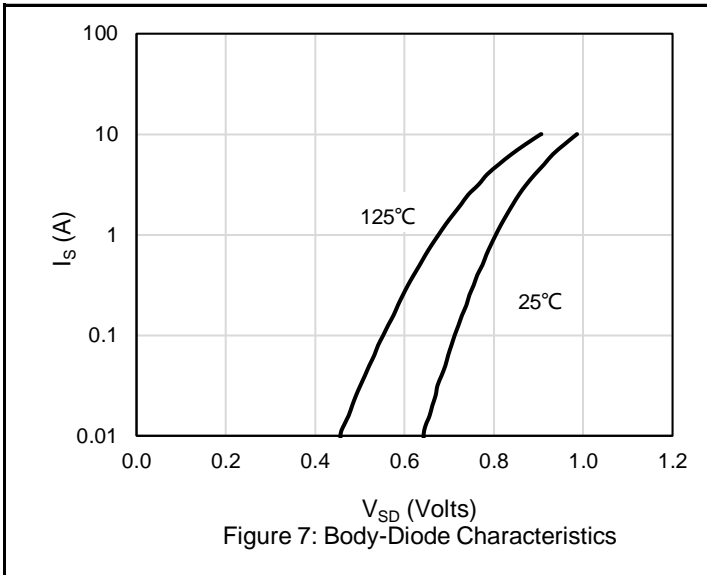
Notes:

1. The max drain current rating is package limited
2. Repetitive Rating: Pulse width limited by maximum junction temperature
3. $L = 100 \text{ mH}$, $V_{DD} = 150\text{V}$, $I_{AS} = 1.2\text{A}$, $R_G = 25 \Omega$, Starting $T_J = 25^\circ\text{C}$, guaranteed by design
4. Mount on minimum PCB layout

Electrical Characteristics ($T_J = 25^\circ\text{C}$ unless otherwise noted)							
Symbol	Parameter	Test Conditions	Min	Typ	Max	Units	
Static Characteristics							
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}$	650			V	
		$V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}$ $T_J = 150^\circ\text{C}$	700	750			
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 650\text{ V}, V_{GS} = 0\text{ V},$			1	μA	
		$V_{DS} = 650\text{ V}, V_{GS} = 0\text{ V},$ $T_J = 150^\circ\text{C}$			100		
I_{GSS}	Gate Leakage Current	$V_{GS} = \pm 30\text{ V}, V_{DS} = 0\text{ V}$			± 100	nA	
$V_{GS(TH)}$	Gate Threshold voltage	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	2.5	3.5	4.5	V	
$R_{DS(ON)}$	Drain-Source on-state resistance	$V_{GS} = 10\text{ V}, I_D = 2\text{ A}$		1	1.2	Ω	
Dynamic Characteristics							
C_{ISS}	Input Capacitance	$V_{DS} = 50\text{ V}, V_{GS} = 0\text{ V},$ $F = 100\text{ kHz}$		265		pF	
C_{OSS}	Output Capacitance				30.4		pF
C_{RSS}	Reverse Transfer Capacitance				0.5		pF
R_G	Gate Resistance	$F = 1\text{ MHz}$		21		Ω	
Switching Characteristics							
$T_{D(ON)}$	Turn On Delay Time	$V_{DD} = 520\text{ V}, I_D = 4\text{ A},$ $V_{GS} = 10\text{ V}, R_G = 25\ \Omega$		11.8		nS	
T_R	Rise Time			24.6		nS	
$T_{D(OFF)}$	Turn Off Delay Time			34.4		nS	
T_F	Fall Time			25.4		nS	
Q_G	Total Gate Charge	$V_{DD} = 520\text{ V}, I_D = 4\text{ A},$ $V_{GS} = 10\text{ V}$		12.2		nC	
Q_{GS}	Gate-Source Charge			3.8		nC	
Q_{GD}	Gate-Drain Charge			5.2		nC	
Drain-Source Diode Characteristics and Maximum Ratings							
I_S	Maximum Continuous Body-Diode Forward Current			4		A	
I_{SM}	Maximum Pulsed Body-Diode Forward Current ^(NOTE 1)			12		A	
V_{SD}	Diode Forward Voltage	$V_{GS} = 0\text{ V}, I_S = 4\text{ A}$		0.85		V	
T_{RR}	Reverse recovery time	$V_{DD} = 100\text{ V}, I_D = 4\text{ A},$ $di/dt = 100\text{ A}/\mu\text{S}$		196		ns	
Q_{RR}	Reverse recovery charge			1280		nC	
I_{RRM}	Peak Reverse Recovery Current			-11.2		A	

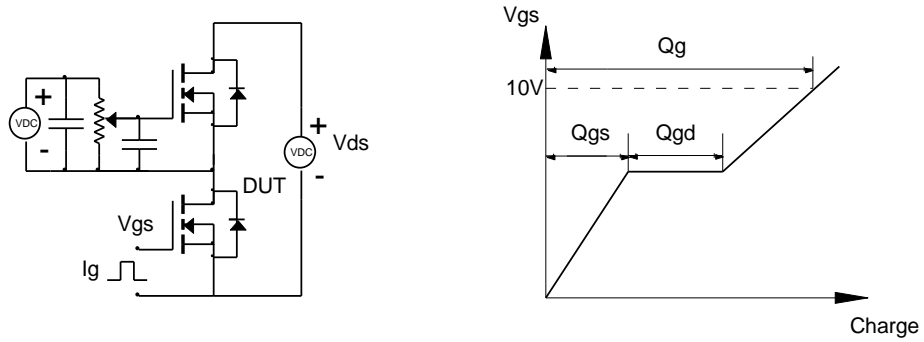
Electrical Characteristics Diagrams



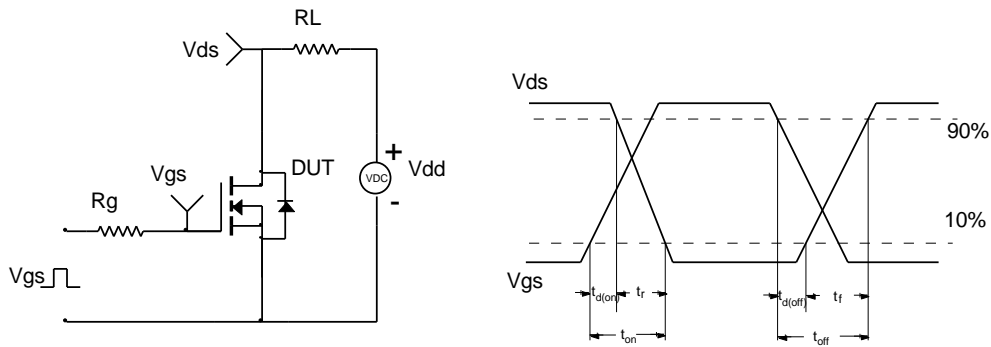


Test Circuit and Waveform

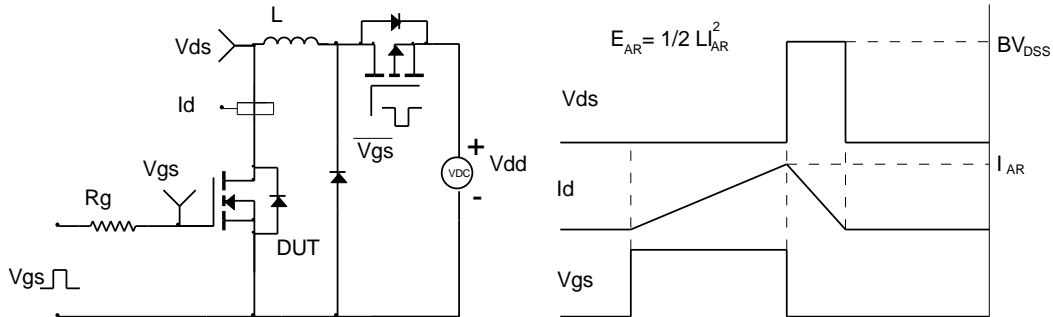
Gate Charge Test Circuit & Waveform



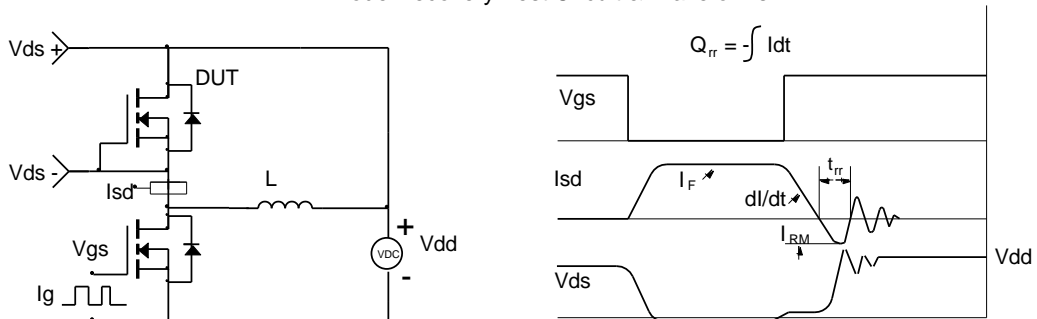
Resistive Switching Test Circuit & Waveforms



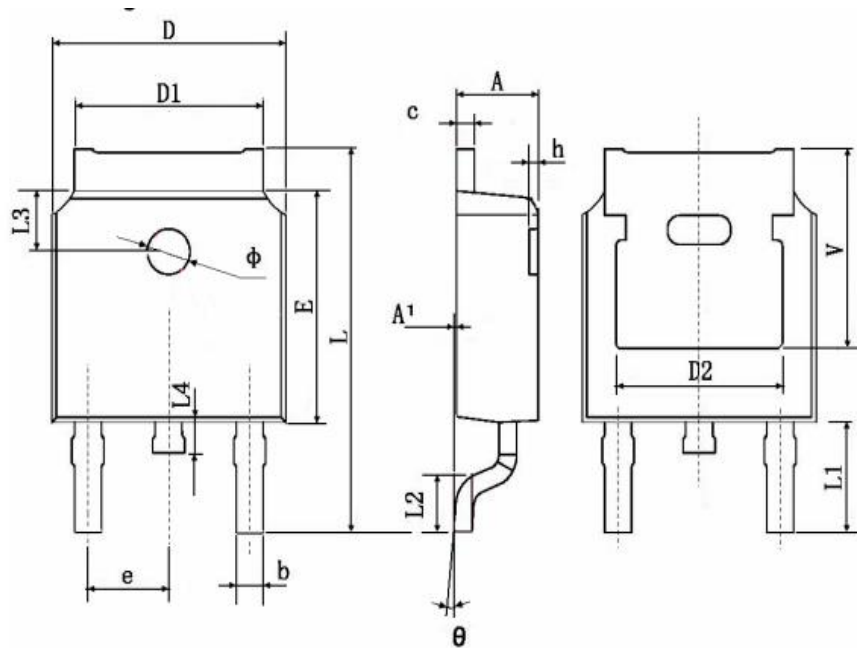
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



Package Outlines



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.250	2.350	0.089	0.093
A1	0.050	0.150	0.002	0.006
b	0.660	0.860	0.026	0.034
c	0.458	0.558	0.018	0.022
D	6.550	6.650	0.259	0.263
D1	5.234	5.434	0.207	0.215
D2	4.826 TYP.		0.191 TYP.	
E	6.050	6.150	0.239	0.243
e	2.236	2.336	0.088	0.092
L	9.820	10.220	0.388	0.404
L1	3.000 TYP.		0.119 TYP.	
L2	1.400	1.600	0.055	0.063
L3	1.800 TYP.		0.071 TYP.	
L4	0.700	0.900	0.028	0.036
Φ	1.150	1.250	0.045	0.049
θ	0°	3°	0°	3°
h	0.000	0.300	0.000	0.012
V	5.399 TYP		0.213 TYP	

Marking Information



Note:

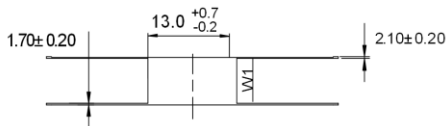
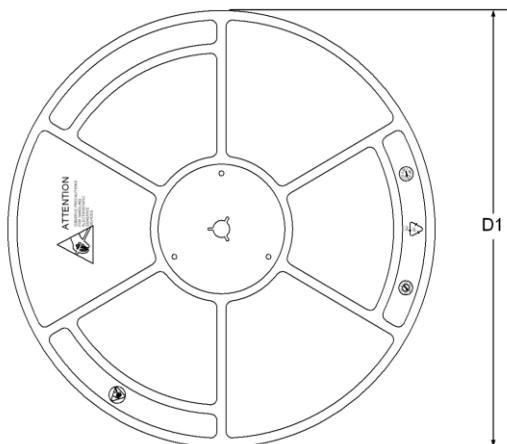
S65N1M2KM = Product Name Code

XXXXXXXX = Date code

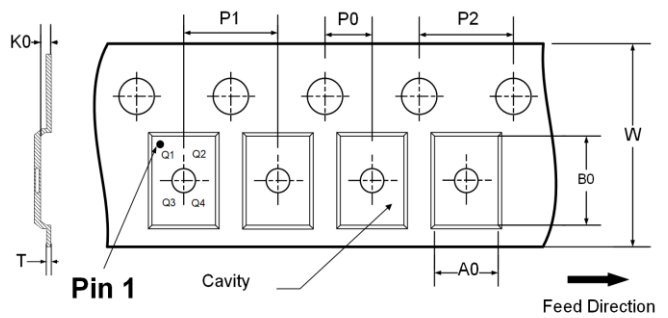
Contact ALKAIDSEMI sales for detail information

Tape & Reel Information

REEL DIMENSIONS



TAPE DIMENSIONS



- A0: Dimension designed to accommodate the component width
- B0: Dimension designed to accommodate the component length
- K0: Dimension designed to accommodate the component thickness
- W: Overall width of the carrier tape
- P0: Pitch between successive cavity centers and sprocket hole
- P1: Pitch between successive cavity centers
- P2: Pitch between sprocket hole
- T: Tape material thickness
- D1: Reel Diameter
- W1: Reel Width

DIMENSIONS										(Unit: mm)	
Reel	D1	W1								Material	Hips
	330	20.5									
Tape	P0	P1	P2	W	A0	B0	K0	T	Pin 1 Quadrant	Material	
	4	8	2	16	6.9	10.5	2.9	0.27	Q1	PC	
All dimensions are nominal											

Revision History

Revision	Release Date	Remark
Rev.1.1	2022/4/10	

Disclaimer

The information given in this document describes the independent performance of the product, but similar performance is not guaranteed under other working conditions, and cannot be guaranteed when installed with other products or equipment. To achieve the required performance of the product in actual scenarios, the customer should conduct a complete application test to assess the functionality of the product.

Alkaidsemi assumes no responsibility for equipment failures result from using products at values that exceed the ratings, operating conditions, or other parameters listed in the product specifications.

The product described in this specification is not applicable for aerospace or other applications which requires high reliability. Customers using or selling these products for use in medical, life-saving, or life-sustaining applications do so at their own risk and agree to fully indemnify.

Due to product or technical improvements, the information described or contained herein may be changed without prior notice.